

A wide-bandwidth, high-power radio-frequency driver for acousto-optic and electro-optic devices

D.S. Barker,^{1, a)} N.C. Pimenti,^{2, b)} and A. Restelli²

¹⁾*Sensor Science Division, National Institute of Standards and Technology
Gaithersburg, MD 20899, USA*

²⁾*Joint Quantum Institute, University of Maryland and National Institute of Standards and Technology
College Park, MD 20742, USA*

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We present a design for a radio-frequency driver that leverages telecom amplifiers to achieve high power output and wide bandwidth. The design consists of two compact printed circuit boards (total area $< 255 \text{ cm}^2$), which incorporate power (turn-on) and thermal management to prevent accidental damage to the amplifier circuitry. Our driver provides $> 1 \text{ W}$ of output power over a 10 MHz to 1.1 GHz frequency range, and $\geq 5 \text{ W}$ from 20 MHz to 100 MHz. The driver circuit includes auxiliary components for analog frequency and amplitude modulation ($\approx 70 \text{ kHz}$ bandwidth), as well as digital power switching ($> 30 \text{ dB}$ of extinction within 40 ns and final extinction $> 90 \text{ dB}$). The radio-frequency source can also be digitally switched between an external input and an integrated voltage-controlled oscillator. Our design is motivated by the need for flexible, inexpensive drivers of optically active devices, such as acousto-optic and electro-optic modulators.

I. INTRODUCTION

Active optical devices are a ubiquitous tool in experimental optics. In particular, electro-optic (EO) and acousto-optic (AO) devices can be used for amplitude, frequency, and phase modulation, as well as beam deflection and polarization control. AO and EO modulators have found applications in a variety of fields, which include ultrafast laser physics,¹ microscopy,² quantum computing,³ and spectroscopy.⁴⁻⁶ These applications often require analog and digital control of both the amplitude and frequency of the modulator's radio-frequency drive. For example, analog frequency modulation is necessary for several spectroscopy techniques,⁷ fast digital amplitude control is crucial for quantum logic operations,³ and analog amplitude control is required for stable optical dipole traps.^{8,9}

AO and EO modulators typically operate in the radio-frequency (RF) range and require $\geq 1 \text{ W}$ of RF power. Depending on the application, the modulator's RF control circuit may require a frequency tuning range $\geq 100 \text{ MHz}$, power control with $\geq 20 \text{ dB}$ of dynamic range, and switching times on the order of 10 ns with $\geq 60 \text{ dB}$ extinction ratio. Commercially-available drivers for AO/EO modulators often have a narrow RF bandwidth and typically offer only a subset of the desired RF controls. Researchers (such as ourselves) often attempt to circumvent the limitations of commercially-available drivers by combining off-the-shelf RF components to produce a custom AO/EO driver.^{10,11} However, both commercial and custom RF drivers are generally suitable only for specific modulators or applications.

We present a design for a high-flexibility AO/EO device driver that has high output power over a wide frequency bandwidth. Our circuit uses a custom power sequencing architecture to leverage recently-released telecom amplifiers, which

allow us to achieve RF signal gain $\geq 30 \text{ dB}$ and output power $\geq 1 \text{ W}$ from 10 MHz to 1.1 GHz. The RF driver consists of two FR4 printed circuit boards (PCBs) with a compact total footprint ($< 255 \text{ cm}^2$). Careful PCB layout keeps the channel temperature of the high-power amplifier well below its maximum rating, even in the absence of forced air cooling. Our design incorporates an array of analog and digital controls, which make it compatible with a variety of applications. The RF driver's output power is continuously tunable with a dynamic range of $\approx 30 \text{ dB}$ and an analog modulation bandwidth of $\approx 70 \text{ kHz}$. During digital switching, the RF power falls by 10 dB in $\approx 25 \text{ ns}$, and by $> 30 \text{ dB}$ within 40 ns, with a final extinction ratio $> 90 \text{ dB}$. The driver also allows digital switching between an integrated voltage-controlled oscillator (VCO), which provides analog frequency tunability, and an external RF source, such as a direct digital synthesizer (DDS) or software-defined radio (SDR).

The RF driver is packaged in a 2U 19" rack enclosure, with the size of the case limited by the driver's linear power supply.¹² We discuss the circuit design in Section II. Design files for both PCBs, including schematics, board layouts, and bills of materials, are available online.^{13,14} Section III contains our measurements of the RF driver's performance. We summarize the results and discuss future modifications to our design in Section IV. The cost of both fully-populated PCBs is $\approx \$1000$ for a run of one. In a production run of 40 RF drivers, the cost per driver, including the rack enclosure and all auxiliary components, was $\$1085$, which is competitive with commercially-available alternatives.

II. CIRCUIT DESIGN

The central features of our design are wide RF amplification bandwidth, high output power, fast digital switching, and high-dynamic-range analog power tuning. These design requirements were informed by the AO/EO devices commonly employed in our laboratories, which fall into four broad

^{a)}daniel.barker@nist.gov

^{b)}npimenti@umd.edu

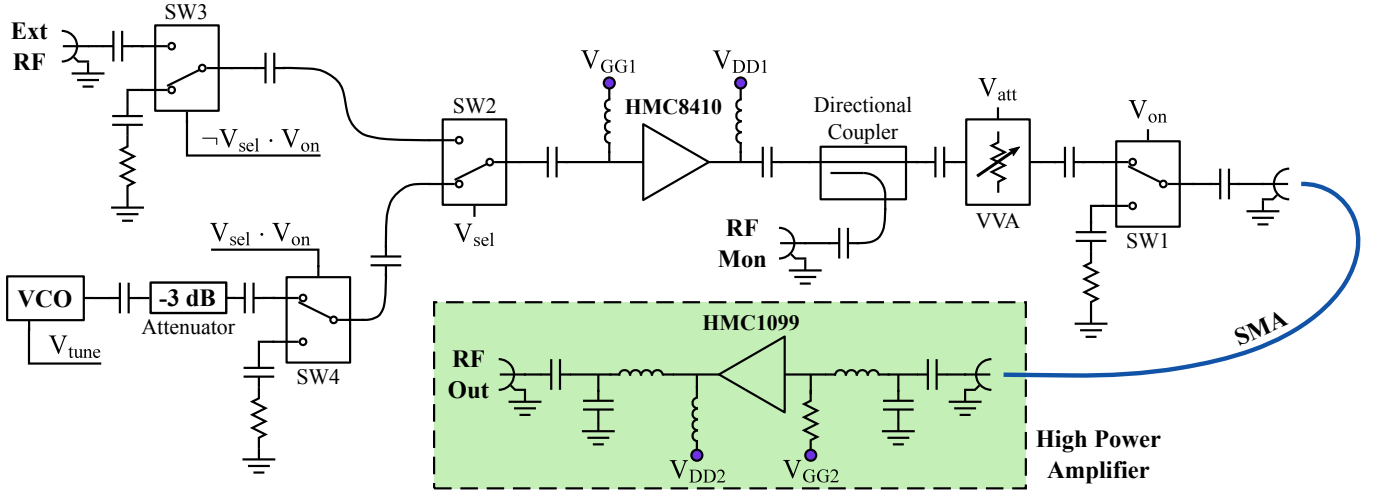


FIG. 1. Schematic of radio-frequency components. The RF switch SW2 selects either the VCO or Ext RF connector as the RF signal source. Switches SW3 and SW4 reduce cross-talk between the two RF signal sources and increase the RF extinction ratio. The RF signal passes from SW2 into a low-noise, wide-bandwidth pre-amplifier (HMC8410),¹⁵ which increases the RF power by ≈ 20 dB. A directional coupler (ADC-20-4) splits off $\approx 1\%$ of the RF power and sends it to the RF Mon output. The RF signal then reaches a voltage-variable attenuator (VVA), which modulates the RF amplitude with a dynamic range of ≈ 30 dB. The switch SW1, in conjunction with SW3/SW4, toggles the RF output power. A short SMA cable connects the pre-amplified RF signal to a separate high power amplifier PCB (highlighted in green), where the RF signal is amplified to ≥ 1 W.

classes: low-power (≈ 1 W) AO modulators for 400 nm to 800 nm wavelengths; high-power (≈ 5 W), low-frequency AO modulators for near-IR wavelengths; resonant free-space EO modulators; and broadband fiber EO modulators. The combination of the RF bandwidth and low frequency (≤ 100 MHz) power requirements pose the most significant obstacle to the realization of an RF driver compatible with all these disparate device classes.

A. RF Amplification and Control

Figure 1 is a diagram of our design's RF components. We arrange the pre-amplifier (HMC8410),¹⁵ directional coupler, voltage-variable attenuator (VVA), and rightmost RF switch (SW1) for better dynamic range and extinction. This component sequence reduces the attainable RF output power due to the insertion losses in SW1, the VVA, and the directional coupler. Our component selection represents a compromise between the competing goals of high output power and dynamic range. The directional coupler picks off $\approx 1\%$ of the power from the pre-amplifier and sends it to a low-power monitor output.¹⁶ The RF components are connected by grounded coplanar waveguides with a designed characteristic impedance of $50\ \Omega$ at 1 GHz. To improve the low-frequency performance, we use 100 nF broadband capacitors to AC-couple the RF signal between components.¹⁷

Two wide-bandwidth, high-gain amplifiers, an HMC1099 and an HMC8410, form the core of our RF driver.^{18,19} The HMC8410 serves as a pre-amplifier, a task for which it is ideally suited due to its low noise figure (≤ 2 dB) and excellent gain flatness (< 1 dB) in our frequency range. The HMC1099 has a saturated output power > 10 W and high power-added

efficiency ($\geq 50\%$ under our operating conditions). It provides high power amplification and is mounted on a separate PCB (green highlighted region in Figure 1) to increase design flexibility. An inline attenuator can be installed between the PCBs to restrict the maximum output power in order to prevent damage to delicate optical devices. Both amplifiers are internally prematched to $50\ \Omega$ across their full operating bandwidth, which greatly simplifies external impedance matching. We based the external impedance matching network, including component selection and placement, on the typical application circuits for each amplifier.^{18–20} Unfortunately, both amplifiers lack internal biasing circuitry and also have strict power sequencing requirements. The gate voltage (V_{GG}), drain voltage (V_{DD}), and RF input must be applied sequentially to each amplifier to prevent damage. We leave discussion of the details of our power sequencing electronics to Section II C.

Four RF switches (MASWSS0178) provide digital control of the power output and signal source of the RF driver.²¹ Each switch has > 50 dB of isolation and a switching time of ≈ 20 ns. Two 5 V TTL logic signals, V_{on} and V_{sel} , govern the state of the RF switches. Switch SW1 turns the RF output on or off depending on whether V_{on} is high or low. Switch SW2 sets the RF source to the VCO when V_{sel} is high, or to the external RF input when V_{sel} is low ($-V_{sel}$ is high). The remaining switches, SW3 and SW4, increase the extinction ratio (when V_{on} is low) or reduce bleed-through of the undesired RF source onto the RF output (depending on the state of V_{sel}).

We use a linear-in-dB, voltage-variable attenuator (F2255) for analog adjustment of the driver's RF output power.²² The VVA has low insertion loss (< 1.7 dB) and a specified attenuation range of 33 dB. However, gain compression in the

high power amplifier limits the dynamic range of the RF driver to ≈ 30 dB. In contrast to its excellent static properties, the F2255 attenuator has a comparatively slow, and poorly specified, response to changes in its control voltage, V_{att} . In applications with lower dynamic range or output power requirements, the VVA can be replaced with a pin-compatible part from another manufacturer, which offer up to ≈ 10 times larger amplitude modulation bandwidths.²³

We employ a VCO as the RF driver's on-board RF source. The VCO is easily controlled and frequency modulated with a tuning voltage, V_{tune} . The RF bandwidth of a VCO is typically much narrower than the bandwidth of the other RF components in our design. Several VCOs could be used in conjunction with a switching network to increase the bandwidth of the on-board RF source, but this strategy would increase cost and complexity. We have instead made the RF driver compatible with all 5 V and 12 V VCOs in the CVCO55 series (from Crystek), or the JTOS and ROS series (from Minicircuits). Most VCOs have sufficient output power to saturate the HMC8410 pre-amplifier. To reduce this effect, and the associated harmonic distortion, we insert a 3 dB fixed attenuator between the VCO and SW4. High-frequency VCOs often have a lower output power, so the fixed attenuator can be replaced with a short when driving high-power, high-frequency devices.

B. Analog and Digital Control

The RF driver allows both internal and external control of the various analog and TTL signals that control its RF output. Several front-panel switches permit the user to choose internal, external, or, for analog signals, summed (internal + external) control of V_{on} , V_{sel} , V_{att} , and V_{tune} . High-speed optocouplers (TLP2767) detect external TTL signals and provide ground isolation.²⁴ We configure the optocouplers to be compatible with both 3.3 V and 5 V TTL logic. A TLP2767 can handle switching waveforms with frequencies as large as 50 MHz at 50 % duty cycle. Analog inputs for amplitude and frequency modulation are sensed pseudo-differentially by instrumentation amplifiers with 10 MHz bandwidth (AD8421). The analog inputs have a 10 k Ω input impedance, and a 50 Ω resistor isolates the input reference level from circuit ground. An on-board microcontroller supplies internal setpoints for the analog voltages V_{att} and V_{tune} using a dual-channel digital-to-analog converter (DAC). Both internal setpoints can be adjusted using a front-panel rotary encoder and LCD display.

Wide-bandwidth op-amps (LM7171) buffer both the internal and external analog control voltages. These op-amps multiply or divide the analog signals such that the output voltage range of both a typical external voltage source and the DAC will span the input range of the VVA or VCO. In the summed control mode, $V_{\text{att}} = V_{\text{att}}^{\text{DAC}} + V_{\text{att}}^{\text{ext}}/3$ and $V_{\text{tune}} = 3(V_{\text{tune}}^{\text{DAC}} + V_{\text{tune}}^{\text{ext}})$. Currently, V_{att} and V_{tune} are only limited by the ± 15 V power rails of the LM7171 op-amps. It is therefore possible to exceed the maximum rating of the VVA control voltage and the tuning voltage of certain VCOs when the driver is operated in either the summed or external control

modes. Future versions of the RF driver may integrate Zener diodes on the op-amp outputs to protect the RF components.

In addition to controlling the DAC, the microcontroller is configured to accept triggers on an auxiliary optocoupled TTL line and to control an AD9910 DDS. A DDS shield PCB (based on the AD9910 evaluation board^{25,26}) can be mounted on to the RF driver, which incorporates several extra voltage regulators to power the DDS. The current version of the microcontroller software permits only manual adjustment of the DDS frequency. The auxiliary TTL trigger enables tabled control of $V_{\text{att}}^{\text{DAC}}$, $V_{\text{tune}}^{\text{DAC}}$, and all DDS parameters to be implemented in future microcontroller software versions. The code base and DDS shield could also be adapted to other AD99XX series synthesizers, some of which can generate sinusoidal waveforms over the full RF amplification bandwidth of our RF driver.²⁷

C. Amplifier Power Sequencing and Bias Control

The performance of monolithic microwave integrated circuit (MMIC) amplifiers, such as the HMC1099 and HMC8410, depends sensitively on the amplifier's drain current, I_{DD} . The drain current depends on the gate and drain voltages (V_{GG} and V_{DD}) as well as the input RF power. Excessive drain current can damage the amplifier, so V_{GG} , V_{DD} , and the RF signal must be applied to the amplifier sequentially.

There are two methods for biasing I_{DD} : constant gate voltage and constant drain current.²⁸ The constant drain current approach has greater long-term repeatability, but tends to restrict maximum power output because the RF input cannot dynamically pull additional current from the V_{DD} supply. In the constant gate voltage technique, V_{GG} is set to produce a particular quiescent drain current, I_{DQ} , prior to activation of the RF input. A fixed V_{GG} allows the amplifier to pull additional drain current as the RF input power increases, which reduces gain saturation. However, the gate voltage that produces the desired I_{DQ} may change as an amplifier ages. Biasing an amplifier with a constant drain current is generally preferable when an amplifier's optimal I_{DQ} is large enough that

$$I_{\text{DQ}} V_{\text{DD}} > P_{\text{sat}}, \quad (1)$$

where P_{sat} is the saturated output power. Condition (1) is valid for the HMC8410 pre-amplifier, but not the HMC1099 high-power amplifier. Consequently, the RF driver employs both drain current biasing procedures.

We control the HMC8410 pre-amplifier using an active bias controller (HMC920LP5E), which also ensures proper sequencing of V_{GG1} and V_{DD1} during start up and shut down (see Figure 1). Our bias control circuit is an amalgamation of example circuits from the HMC920LP5E and HMC8410 datasheets.^{19,29} To increase the pre-amplifier's saturated output power, we bias the HMC8410 with $V_{\text{DD1}} = 6.4$ V and $I_{\text{DD1}} = 75$ mA. Operating the HMC8410 under these bias conditions, at the high end of the permitted range, slightly degrades its noise figure. In applications with lower power re-

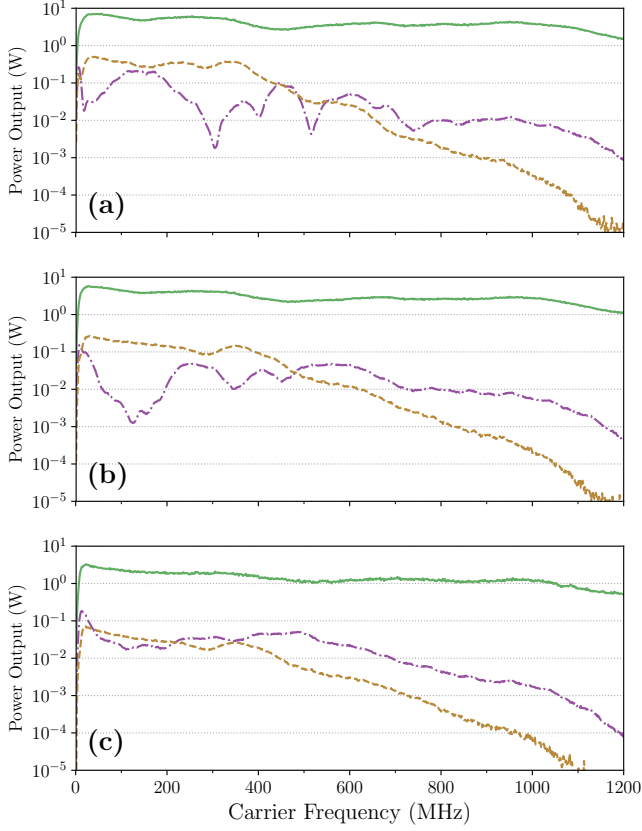


FIG. 3. Power output in the 1st, 2nd and 3rd harmonics (green solid, purple dash-dotted, and gold dashed lines, respectively) as a function of carrier frequency. The RF power applied to the external input is {10 mW, 3.2 mW, 1 mW} in subplot {(a), (b), (c)}.

mal resistance of the HMC1099 is $11.2 \text{ }^\circ\text{C W}^{-1}$, so the junction temperature is $\lesssim 140 \text{ }^\circ\text{C}$ under passive cooling (the absolute maximum junction temperature for the HMC1099 is $225 \text{ }^\circ\text{C}$). However, the absolute maximum case temperature for the HMC1099 is only $85 \text{ }^\circ\text{C}$ and our measurements suggest that the amplifier temperature could approach this limit in environments with ambient temperatures $> 20 \text{ }^\circ\text{C}$. For this reason, laboratories with poor temperature stability should either use forced-air cooling (as we suggest above) or a custom copper heatsink to improve the thermal performance.

III. RESULTS

We show the RF power output of our design in Figure 3. We measured the RF power in the 1st, 2nd, and 3rd harmonic as function of frequency using a Rohde & Schwarz FSV scalar network analyzer with a controllable SMB100A tracking generator. The RF output of the tracking generator was connected to the external RF input of a test driver, which was attached to the network analyzer through a 30 dB attenuator and a DC block. The transmission losses of the external RF components and cables were calibrated out by the network analyzer. For a 1 mW input power, our driver outputs $> 1 \text{ W}$ for input fre-

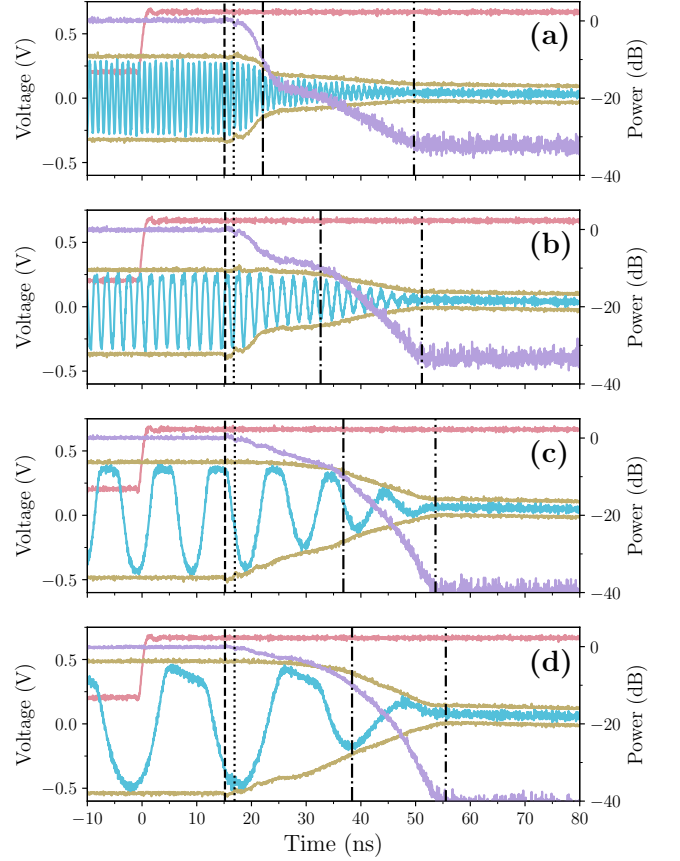


FIG. 4. Digital switching performance of the RF driver at input frequencies of 1 GHz (a), 500 MHz (b), 100 MHz (c), and 50 MHz (d). Each subplot shows the RF waveform (blue), RF envelope (gold), and TTL signal (red) on the left axis. The relative peak-to-peak power, P_{pp} , (see Equation 2) is plotted against the right axis in purple. The TTL signal is vertically offset for clarity. The vertical dashed line marks the initial response of the RF output and the vertical {dotted, dash-dotted, dash-dot-dotted} lines show the time at which the RF output falls to {90 %, 10 %, < 0.1 %} of its initial value. For all of these data, the VVA was set for minimum attenuation. The harmonic distortion that is apparent in each subplot is consistent with the measurements in Figure 3.

quencies from 10 MHz to 1 GHz (see Figure 3 (c)). When we increase the input power to 3.2 mW (Figure 3 (b)) or 10 mW (Figure 3 (a)), the driver can output $> 1 \text{ W}$ at frequencies up to 1.2 GHz and $\geq 5 \text{ W}$ from in the 20 MHz to 100 MHz frequency range. The increase in carrier output power is accompanied by an increase in harmonic distortion, particularly at frequencies $\lesssim 400 \text{ MHz}$ and in the 3rd harmonic. The harmonic distortion (referred to the carrier) is always $< -10 \text{ dB}$ inside the RF driver's operating bandwidth and agrees with the 2nd harmonic data in the HMC1099 datasheet.^{18,31}

Commercially-available RF drivers that specify harmonic distortion typically report harmonic content (referred to the carrier) $< -15 \text{ dB}$ or $< -20 \text{ dB}$. Our driver meets the less-stringent specification at low input power (Figure 3 (c)) except for frequencies $\lesssim 30 \text{ MHz}$ and in the range from 400 MHz to

525 MHz. The driver also meets the more-stringent specification at all input powers for frequencies > 700 MHz. When driving narrow-bandwidth AO or EO devices, the harmonic distortion is unlikely to be problematic because higher harmonics will be filtered by the device itself. Additional external filtering may be beneficial for applications involving wide-bandwidth devices, such as fiber EO modulators, especially when the bandwidth of the device exceeds the bandwidth of the RF driver. However, broadband AO/EO devices typically require less RF drive power and have non-linear response to weak RF drives. These device characteristics tend to reduce both the amount of harmonic distortion and its effect. We estimate that, for a broadband fiber phase modulator driven at a typical half-wave voltage (≈ 5 V) and a harmonic distortion (referred to the carrier) of -13 dB, the fractional power in the first-order sidebands associated with the dominant harmonic will be $< 10\%$. For lower modulations depths (*i.e.* when only the first-order sidebands contain appreciable power), the fractional power in the first-order sidebands associated with the dominant harmonic will be $\leq 1\%$.

We evaluated the switching time of the RF driver using a DSA72004B 20 GHz bandwidth oscilloscope. A DG4162 waveform generator drove the digital power control input of the RF driver with a 5 V TTL signal at a frequency of 100 kHz. Figure 4 displays the TTL signal, RF waveforms, and RF envelopes acquired at several input frequencies. Using the upper and lower envelopes ($V_{\text{upper}}(t)$ and $V_{\text{lower}}(t)$), we compute the relative peak-to-peak power

$$P_{\text{pp}}(t) = \frac{(V_{\text{upper}}(t) - V_{\text{lower}}(t))^2}{(V_{\text{upper}}(0) - V_{\text{lower}}(0))^2}, \quad (2)$$

which we plot on the righthand axis in Figure 4. The peak-to-peak power begins to decrease ≈ 15 ns after the arrival of the TTL signal edge (vertical dashed line in Figure 4). This propagation delay is consistent with the specifications of the optocouplers and TTL logic chips that drive SW1 through SW3 (the delay due to mismatched cable lengths is ≤ 1 ns). Once the RF switches begin to turn off, P_{pp} diminishes by 10 dB within 25 ns (vertical dash-dotted line in Figure 4) and it falls below the noise floor of our measurement technique, ≤ -30 dB, within 40 ns (vertical dash-dot-dotted line in Figure 4). The switching time is consistent with the specification of the RF switches and is comparable to rise/fall times of commercially-available drivers (the fall time of our driver is the distance between the vertical dotted and dash-dotted lines in Figure 4). Changing from a 5 V to a 3.3 V TTL input signal increases the propagation delay by several nanoseconds, but does not increase the switch-off time. Note that the root-mean-square power, which is the true figure of merit, falls at least as quickly as P_{pp} , so the switching times that we quote represent an upper bound on the performance of the RF driver in laboratory applications. The full turn-on time for the RF output is approximately a factor of two longer than the turn-off time (the positive voltage envelope responds less quickly during turn-on), which limits the maximum digital modulation frequency to $\lesssim 10$ MHz (at 50 % duty cycle). The RF switches have a symmetric switching time specification, so the asymmetry of the rise and fall times of the RF driver is likely caused

by asymmetric response of the high-power amplifier.

We investigated the final RF extinction ratio using the FSV network analyzer. The tracking generator sent 1 mW of RF power to the driver and the network analyzer recorded the RF output with V_{on} held low. We measured the RF power output with the VVA set for both minimal and maximal attenuation. The extinction is the difference between the measured RF output with V_{on} low and V_{on} high. To calculate an extinction noise floor, we also acquired the RF output power with the driver's RF input terminated, V_{on} held low, the VVA set for maximum attenuation, and the tracking generator turned on.³² Figure 5 shows the results of our extinction measurements. Regardless of the VVA attenuation setting, we observe extinction ratios > 90 dB over the full RF bandwidth of the RF driver, and > 110 dB for frequencies < 400 MHz. The noise floor for our measurement varies with frequency, but always corresponds to an extinction ratio > 125 dB. The extinction ratios that we observe, to the best of our knowledge, surpass the specification of any commercially-available driver by at least 20 dB.

The modulation bandwidth of the VVA is not well specified and RF amplitude modulation bandwidth is important in several applications (*e.g.* laser intensity stabilization⁸). To study the AM bandwidth of the RF driver, we set $V_{\text{att}}^{\text{DAC}}$ to the center of the VVA's linear-in-dB range and drove $V_{\text{att}}^{\text{ext}}$ with a sinusoid. The network analyzer recorded the amplitude of the modulation of the RF output as a function of the modulation frequency. Because the FSV is a scalar network analyzer, we cannot measure the full amplitude modulation transfer function of the RF driver. Figure 6 shows the relative magnitude of the amplitude modulation response for sev-

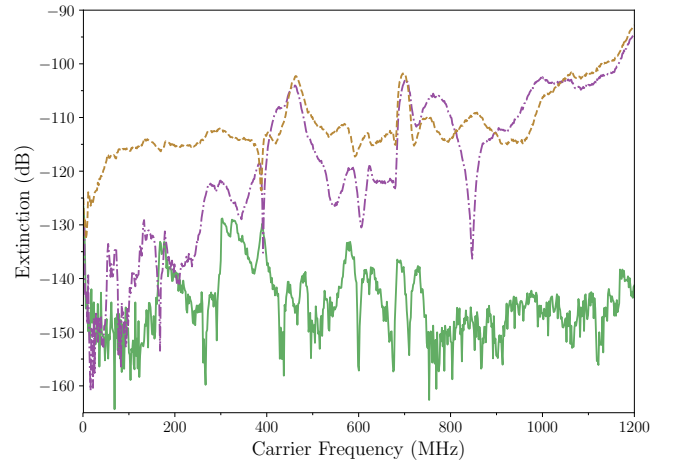


FIG. 5. Extinction of the RF output as a function of frequency at 1 mW input power. Each trace is the difference between the carrier output power with V_{on} low and V_{on} high (the solid green curve in Figure 3 (c)). The gold dashed (purple dash-dotted) curves show the extinction with the minimum (maximum) VVA attenuation setting. The green solid line represents the noise floor of the measurement. We acquired the V_{on} low portion of the data for the noise floor measurement with the RF input to the driver terminated, but with the tracking generator turned on and the VVA attenuation maximized.

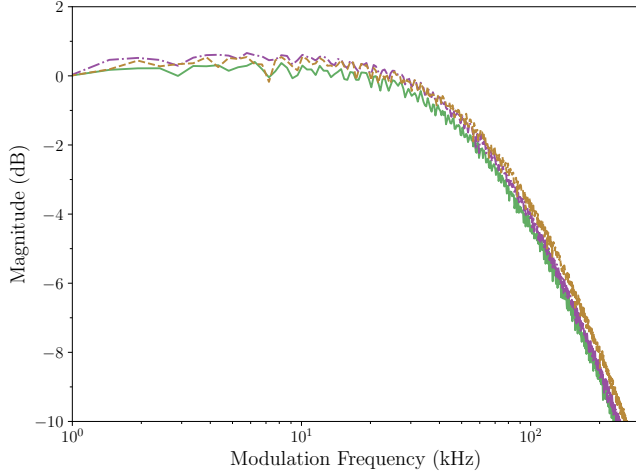


FIG. 6. Relative RF output amplitude modulation as a function of modulation frequency. The green solid, gold dashed, and purple dash-dotted lines show the relative magnitude of the RF output response for sinusoidal peak-to-peak modulation depths of 100 mV, 200 mV, and 400 mV, respectively. The {100 mV, 200 mV, 400 mV} peak-to-peak modulation depth corresponds to a peak-to-peak RF power variation of {3 dB, 6 dB, 12 dB} at DC.

eral modulation depths. The amplitude modulation bandwidth increases slightly with increasing modulation depth and the 3 dB point for the lowest modulation depth is ≈ 70 kHz.³³ Our measurement is in reasonable agreement with the small-signal modulation bandwidth suggested by the F2255 VVA datasheet (≈ 65 kHz). In applications where wider modulation bandwidths are necessary, the VVA can be replaced with a pin-compatible part with ≈ 10 times faster response.²³

IV. CONCLUSION

We have designed and characterized an RF driver for AO and EO devices. The driver achieves high output power and

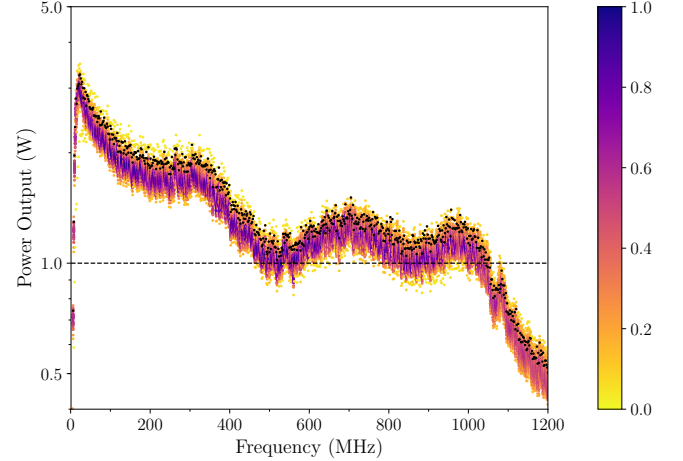


FIG. 7. Output power for RF drivers from the initial production run. The external RF input power for these data is 1 mW. The output powers are binned by frequency and colored according to the normally distributed probability of occurrence for a given output power. The color scale is normalized to the most probable output power in each bin. Black dots show the output power for the test driver that we used to acquire the data in Section III. The black dashed horizontal line is a guide to the eye. The device-to-device variation in the output power is within the specification of the amplifiers and is exaggerated by our measurement's resolution bandwidth, which is 10 kHz.

wide RF bandwidth using telecom amplifiers, which are fully protected during power cycles by a combination of custom and commercial power sequencing electronics. The driver includes flexible controls for AM, FM, and digital switching of the RF output. In addition to the test data on a single driver that we relate in Section III, we also have more limited data from a production run of 40 drivers. We present the power output performance of drivers from the production run in Figure 7 and Table I. Our design could easily be modified to increase digital switching speed, analog AM bandwidth, or extinction ratio at the expense of power output. Additionally, our power sequencing and bias control electronics can easily be adapted for other amplifiers and applications. All design materials are available online for others to use.^{13,14}

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TABLE I. Maximum power output of the production run RF drivers when using the integrated VCO as the RF source. Voltage-controlled oscillators with nominal frequencies of {40 MHz, 80 MHz, 200 MHz, 400 MHz, 800 MHz} were installed in {4, 22, 6, 1, 3} drivers. We report the mean and standard deviation of the maximum output power for each VCO frequency class with the 3 dB fixed attenuator installed before the pre-amplifier (see Figure 1). The larger relative output power variation at 800 MHz is caused by output power differences between VCOs (we used two 800 MHz VCO models, due to product discontinuation).

VCO Frequency	Output Power
40 MHz	5.3(1) W
80 MHz	4.6(2) W
200 MHz	3.7(1) W
400 MHz	1.9 W
800 MHz	1.4(2) W

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- ¹²The PCBs could easily be adapted for various modular electronics crates (e.g. Eurocard, NIM). The crate's bus would need to source ≈ 1 A at 24 V per installed RF driver.
- ¹³<https://github.com/JQIamo/aom-driver>.
- ¹⁴<https://github.com/JQIamo/GaN-Amplifier>.
- ¹⁵The identification of commercial products is for information only and does not imply recommendation or endorsement by the National Institute of Standards and Technology.
- ¹⁶Future versions of our design will use two directional couplers placed before SW3 and SW4 (see Figure 1) as this change will increase both flexibility and maximum output power.
- ¹⁷Results from an early prototype suggest that similar performance can be achieved at lower cost using 10 nF standard capacitors with a high self-resonant frequency.
- ¹⁸*HMC1099 GaN Power Amplifier*, Analog Devices (2016), Rev. A.
- ¹⁹*HMC 8410 Low Noise Amplifier*, Analog Devices (2016), Rev. 0.
- ²⁰Analog Devices Technical Support, Private Communication (2017).
- ²¹*MASWSS0178 SPDT High Isolation Terminated Switch*, Macom, Rev. V4.
- ²²*IDTF2255NLGK Datasheet*, Integrated Device Technology (2017), REV 1.
- ²³Possible replacements include RFSA2033 and RFSA2113, which increase modulation bandwidth at the expense of dynamic range and power output, respectively.
- ²⁴*TLP2767*, Toshiba (2016), Rev. 1.0.
- ²⁵*AD9910 Direct Digital Synthesizer* (2016), Rev. E.
- ²⁶<https://github.com/JQIamo/ad9910-dds>.
- ²⁷*AD9914 3.5 GSPS Direct Digital Synthesizer with 12-Bit DAC*, Analog Devices (2016), Rev. F.
- ²⁸K. Kaya, *AN-1363 Application Note: Meeting the Biasing Requirements of Externally Biased RF/Microwave Amplifiers with Active Bias Controllers*, Analog Devices (2016), Rev. 0.
- ²⁹*HMC920LP5E Active Bias Controller*, Analog Devices, v07.1013.
- ³⁰*LTC2924 Quad Power Supply Sequencer*, Linear Technology (2016), REV C.
- ³¹Our power sequencing electronics could be adapted for other high-power amplifiers with superior 2nd harmonic distortion. These amplifiers require $V_{DD} > 24$ V, so an additional power supply would be necessary.
- ³²We find that RF pickup from the tracking generator, even when it is not attached to the RF driver, is an important contribution to the measured RF spectrum.
- ³³When using the RF driver to intensity stabilize several laser beams, we have observed intensity locking bandwidths $\gtrsim 60$ kHz. This observation suggests that the VVA has reasonable phase margin at the 3 dB point.